506969623 11/10/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7016461

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
VINAY JAIN	09/25/2021
ASHISH GUHA	09/24/2021
SHRADDHA JOSHI	09/23/2021
FELIX HOFMANN	09/02/2021
BETTINA HÖLZER	08/11/2021
HANS BÄR	08/16/2021

RECEIVING PARTY DATA

Name:	EVONIK OPERATIONS GMBH
Street Address:	RELLINGHAUSER STRASSE 1-11
City:	ESSEN
State/Country:	GERMANY
Postal Code:	45128

PROPERTY NUMBERS Total: 1

Property Type	Number
PCT Number:	EP2020061872

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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SIGNATURE:	/Malika Ash Shakur/
DATE SIGNED:	11/10/2021

PATENT 506969623 REEL: 058069 FRAME: 0064

Total Attachments: 18 source=003776USPCT_Assignments#page1.tif source=003776USPCT Assignments#page2.tif source=003776USPCT_Assignments#page3.tif source=003776USPCT_Assignments#page4.tif source=003776USPCT_Assignments#page5.tif source=003776USPCT_Assignments#page6.tif source=003776USPCT_Assignments#page7.tif source=003776USPCT_Assignments#page8.tif source=003776USPCT Assignments#page9.tif source=003776USPCT_Assignments#page10.tif source=003776USPCT_Assignments#page11.tif source=003776USPCT_Assignments#page12.tif source=003776USPCT Assignments#page13.tif source=003776USPCT_Assignments#page14.tif source=003776USPCT_Assignments#page15.tif source=003776USPCT_Assignments#page16.tif source=003776USPCT Assignments#page17.tif source=003776USPCT Assignments#page18.tif

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as ASSIGNOR(S)) have made an invention entitled:

PROCESS FOR PREPARING FILLED HARD-SHELL CAPSULES WITH (METH)ACRYLATE COPOLYMER BASED COATINGS WITH A CAPSULE-FILLING MACHINE

for which an International application was filed on April 29, 2020 and was assigned the Application No. PCT/EP2020/061872; and

WHEREAS, Evonik Operations GmbH, a corporation of Germany, whose post office address is Rellinghauser Strasse 1-11, 45128 Essen, Germany (hereinafter referred to as ASSIGNEE), is desirous of securing the entire right, title, and interest in and to the aforesaid invention and/or any improvements thereon in all countries throughout the world, and in and to the application(s) for Letters Patent on the aforesaid invention and/or any improvements thereon and the Letters Patent to be issued upon the aforesaid U.S. and/or International application(s);

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ASSIGNOR(S) hereby covenant that ASSIGNOR(S) have full right to convey the entire interest herein assigned, and that ASSIGNOR(S) have not executed, and will not execute, any agreement in conflict herewith;

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Duly, executed by the undersigned inventors on the date opposite his/her name:

Date: 25/05/2024	Signature of Inventor: JAIN, Vinay E 19,20, Tarabaug Estate, Raja Ram Mohan Roy Road, Charni Road East 400004 Mumbai India
Date:	Signature of Inventor: GUHA, Ashish Majestica - E104, Lodhu Casa Bella, Palava, Kalyan shil road, Dombivli East 421204 Mumbai India
Date:	Signature of Inventor: JOSHI, Shraddha Flat no. 1203, 13th floor, B wing Newa garden, Phase 1, Sector 20A, Plot 1, Airoli 400708 Thane India

Attorney Docket No.: 2019P00109WOUS

Date:	Signature of Inventor:
	HOFMANN, Felix
	Susan-Sontag-Weg 5
	64285 Darmstadt
	Germany
Date:	Signature of Inventor:
	HÖLZER, Bettina
	Darmstädter Strasse 9a
	64625 Bensheim
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	<u> Сепнаву</u>
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Date:	Signature of Inventor:
	BÄR, Hans
	Hochstr. 36a
	64720 Michelstadt
	Germany

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	400004 Mumbai India
)	***************************************
Date:	Signature of Inventor:
24/09/2021	GUMA, ASBISD
` `	Majestica - E104, Lodha Casa Bella, Palava,
	Kalyan shil road, Dombiyli East
·	421204 Mumbai
	India
Date	Signature of Inventor:
	JOSHI, Shraddha
	Flat no. 1203, 13th floor, B wing
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	GUHA, Ashish	
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	India	
YV-t	Signature of Inventor:	
Date:	Signature of inventor.	·*************************************
23 9 2021	MANGERI Chair Adha	
The state of the s	JOSIII, Shraddha	
	Flat no. 1203, 13th floor, B wing	
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	400708 Thane	
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) Webs 1804:

Date: (CO2/1-03-0)	Signature of Inventor: HOFMANN, Felix Susan-Sontag-Weg 5 64285 Darmstadt Germany
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(Sheet 3 of 3)